

N-channel Enhancement Mode Mosfet

CX4520

DESCRIPTION

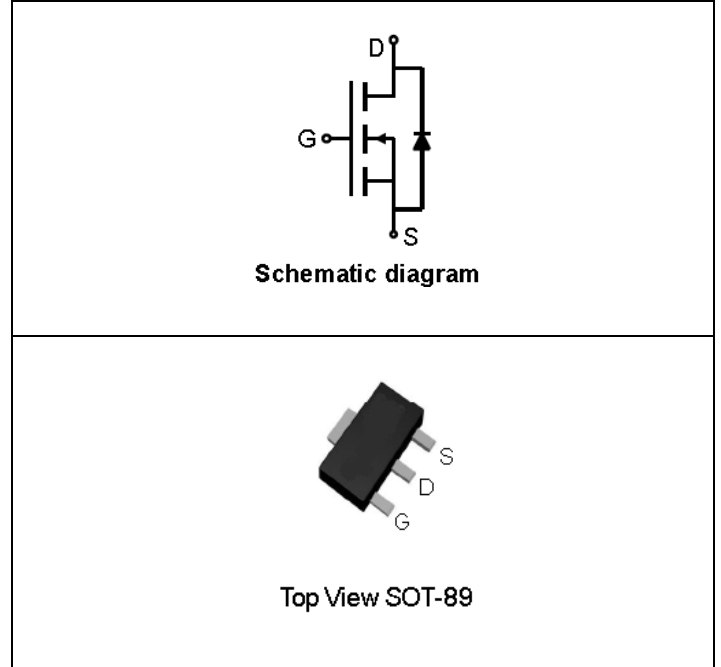
The CX4520 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- RDS(ON) <22mΩ @ VGS=4.5V
RDS(ON) <15mΩ @ VGS=10V
- High Power and current handling capability
- Lead free product is acquired
- Surface Mount Package

Application

- PWM applications
- Load switch
- Power management



ABSOLUTE MAXIMUM RATINGS(T_A=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	45	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current @ Continuous(Note 2)	I _D (25°C)	30	A
	I _D (100°C)	20	A
Drain Current @ Current-Pulsed (Note 1)	I _{DM}	112	A
Maximum Power Dissipation (T _A =25°C)	P _D	35	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance,Junction-to-Ambient (Note 2)	R _{θJA}	35	°C/W
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ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	45			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1		2	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =15A		16	22	mΩ
		V _{GS} =10V, I _D =15A		12	15	mΩ
DYNAMIC CHARACTERISTICS (Note4)						
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, F=1.0MHz		930	1350	PF
Output Capacitance	C _{oss}			135	190	PF
Reverse Transfer Capacitance	C _{rss}			110	160	PF
SWITCHING CHARACTERISTICS (Note 4)						
Turn-on Delay Time	t _{d(on)}	V _{DS} =15V, V _{GS} =10V, R _{GEN} =3.3Ω I _{DS} =15A		4.5		nS
Turn-on Rise Time	t _r			9		nS
Turn-Off Delay Time	t _{d(off)}			32		nS
Turn-Off Fall Time	t _f			5		nS
Total Gate Charge	Q _g	V _{DS} =15V, I _D =15A, V _{GS} =4.5V		15		nC
Gate-Source Charge	Q _{gs}			4.5		nC
Gate-Drain Charge	Q _{gd}			7		nC
Body Diode Reverse Recovery Time	T _{rr}	I _F =5A, dI/dt=100A/μs		20		nS
Body Diode Reverse Recovery Charge	Q _{rr}			10		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V, I _S =1A		0.80	1.2	V

NOTES:

1. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
2. R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design. R_{θJA} shown below for single device operation on FR-4 in still air.



Typical Performance Characteristics

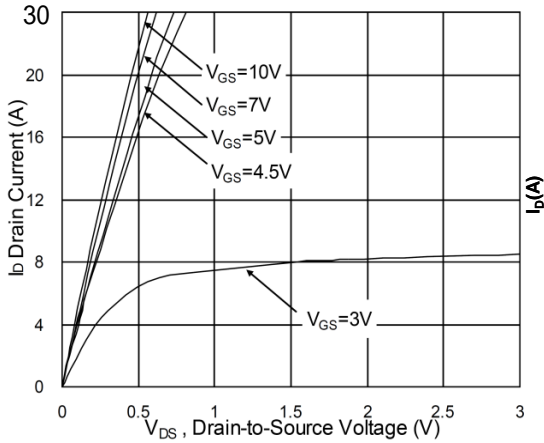


Fig.1 Typical Output Characteristics

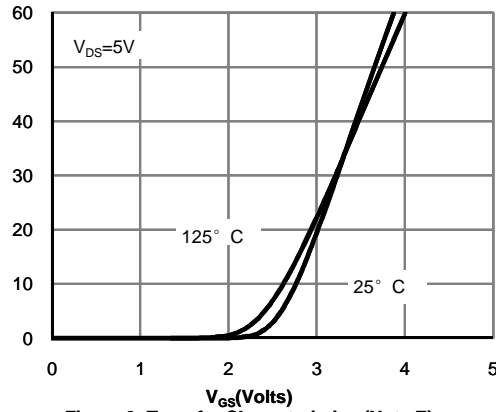


Figure 2: Transfer Characteristics (Note E)

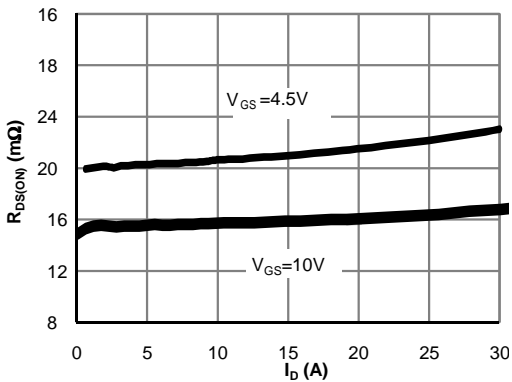


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

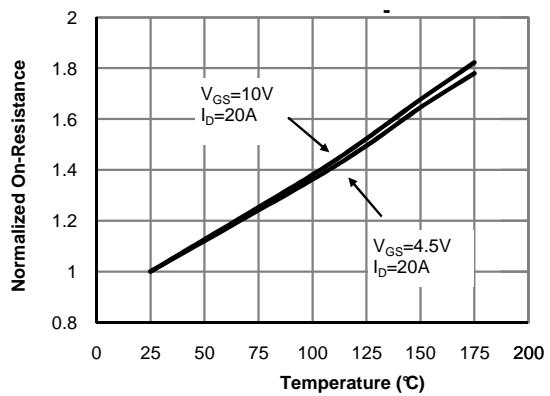


Figure 4: On-Resistance vs. Junction Temperature (Note E)

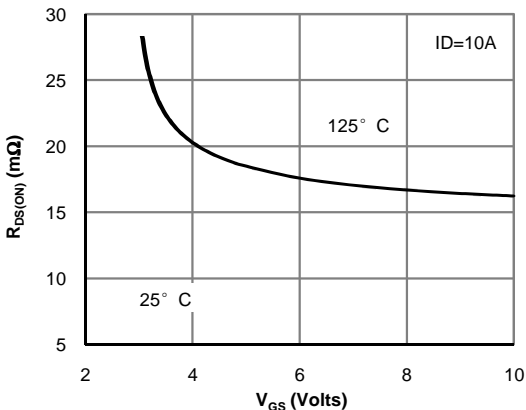


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

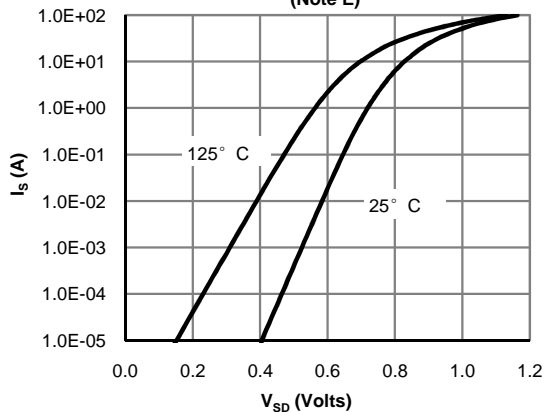
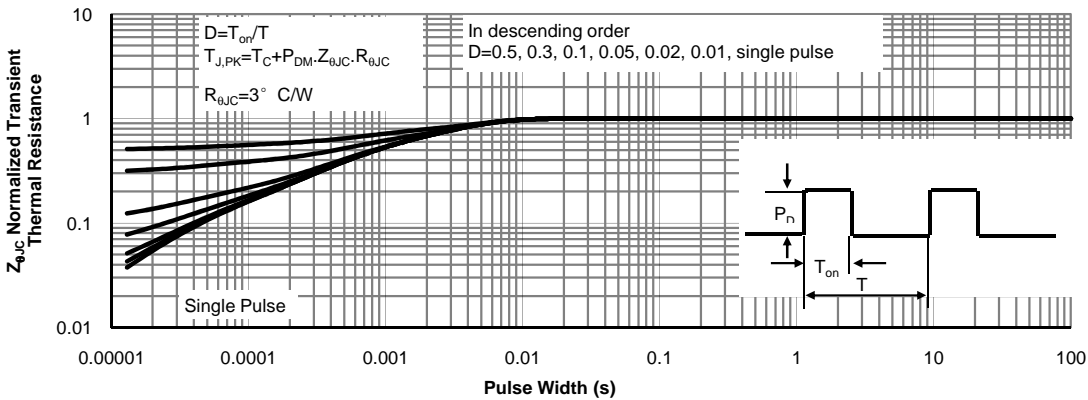
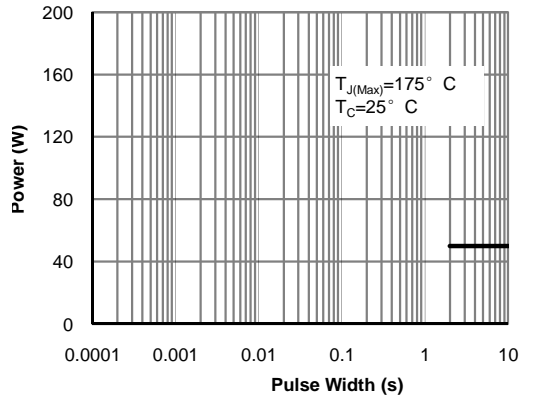
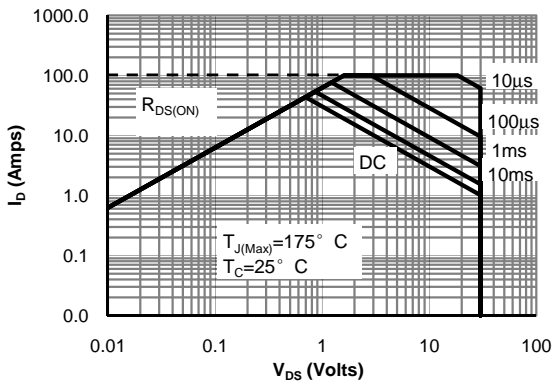
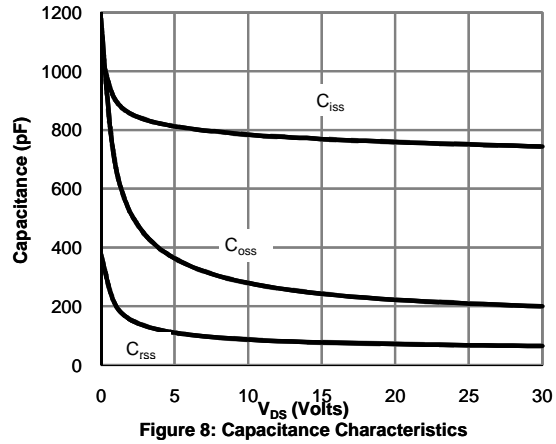
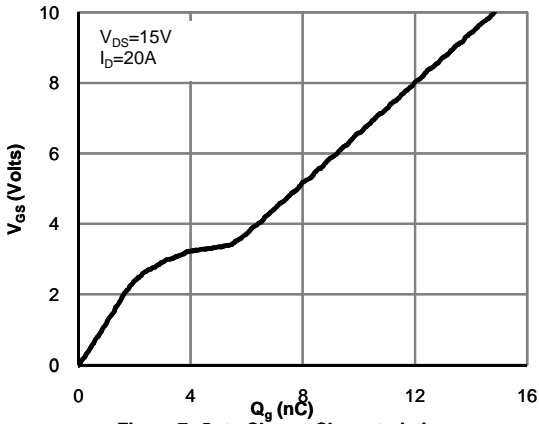


Figure 6: Body-Diode Characteristics (Note E)

■ Typical Performance Characteristics





Typical Performance Characteristics

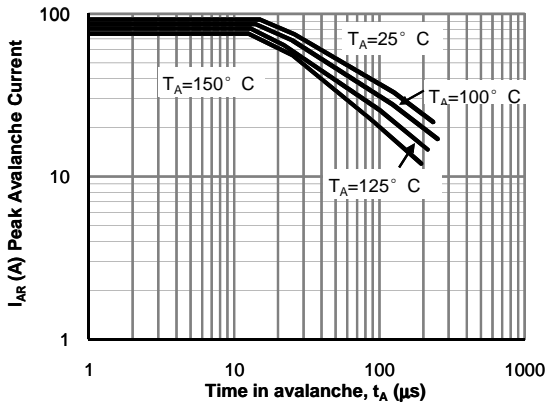


Figure 12: Single Pulse Avalanche capability (Note C)

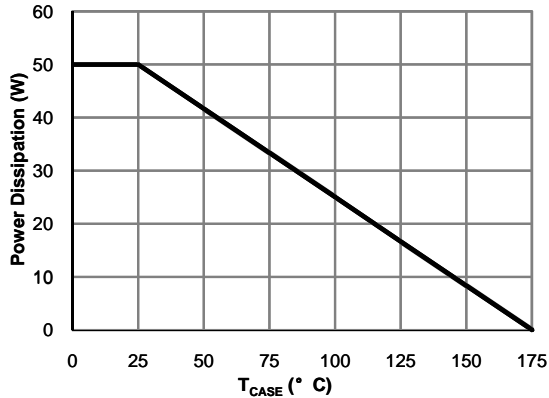


Figure 13: Power De-rating (Note F)

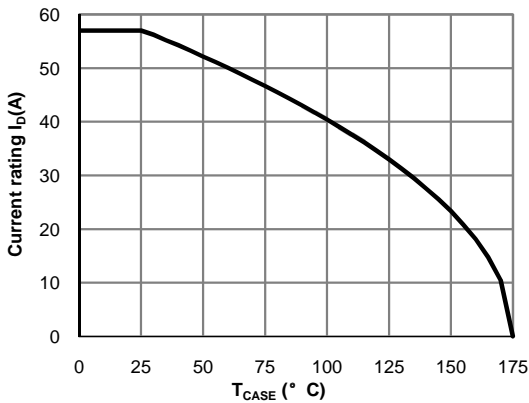


Figure 14: Current De-rating (Note F)

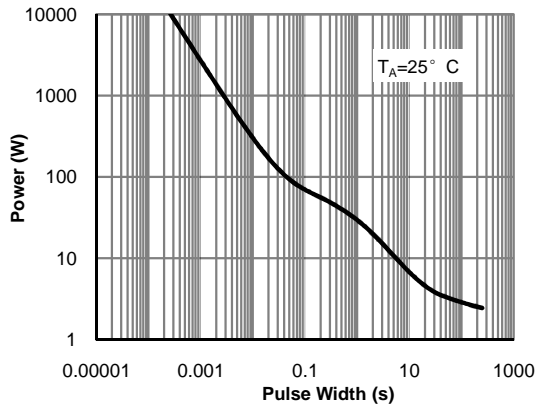


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

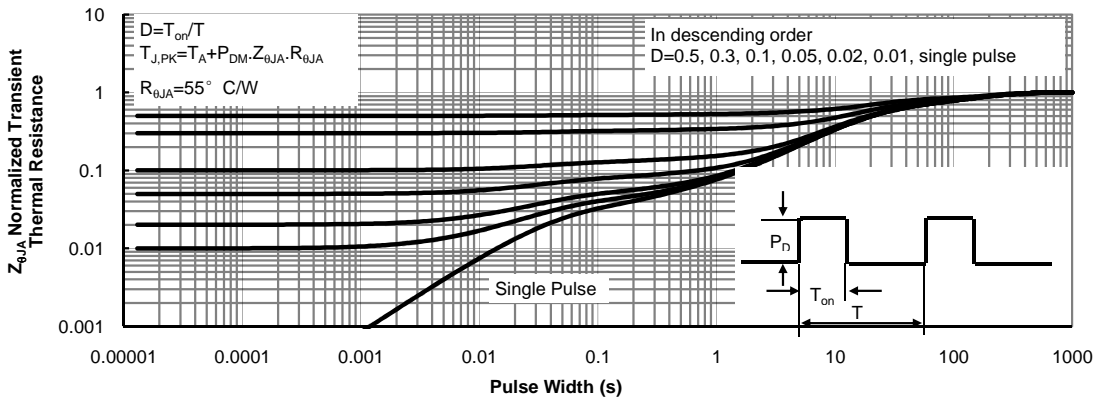
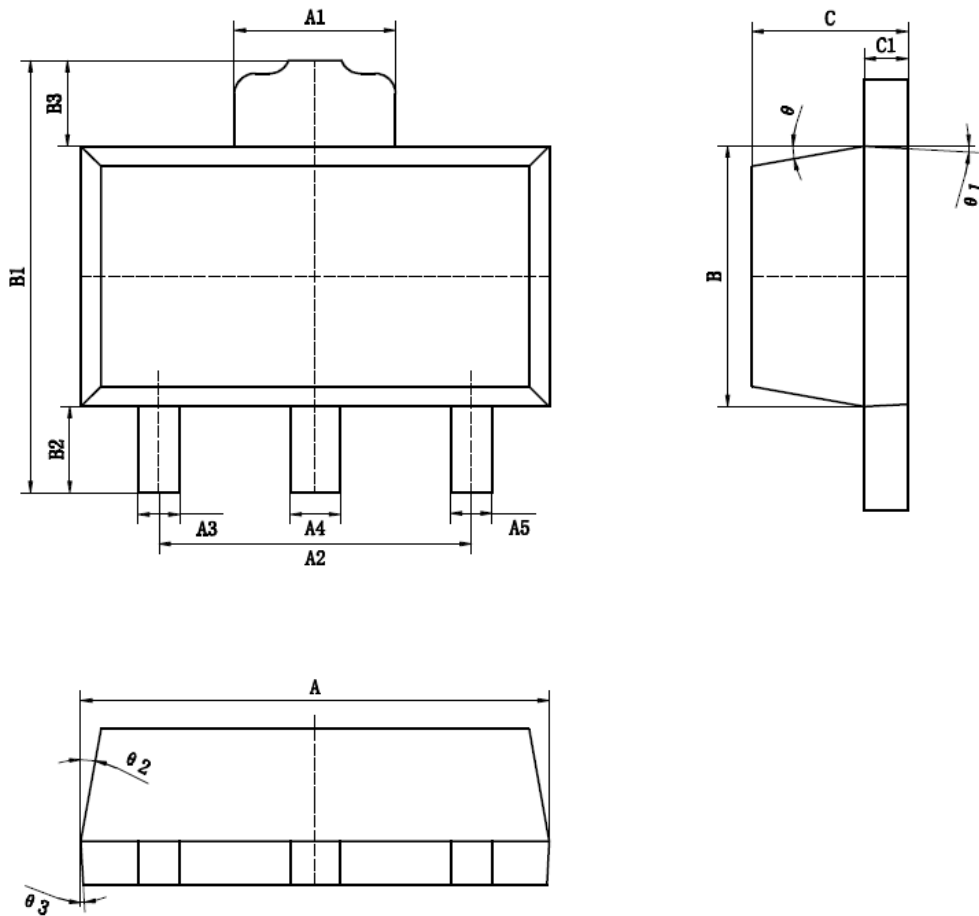


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)



Package Information

SOT89-3 Package



标注	尺寸	最小(mm)	最大(mm)	标注	尺寸	最小(mm)	最大(mm)
A		4.40	4.60	B3		0.82	0.83
A1		1.65	1.75	C		1.40	1.60
A2		2.95	3.05	C1		0.35	0.45
A3		0.35	0.45	theta		6° TYP4	
A4		0.43	0.53	theta 1		3° TYP4	
A5		0.35	0.45	theta 2		6° TYP4	
B		2.40	2.60	theta 3		3° TYP4	
B1		4.05	4.25				
B2		0.82	0.83				